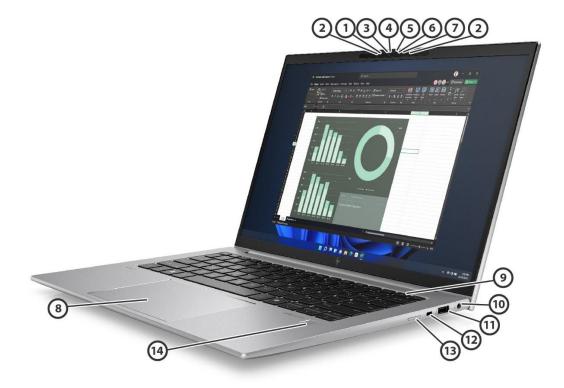
Overview

HP ZBook Firefly 14" G11 Mobile Workstation PC



- 1. Ambient Light Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Webcam
- 5. Camera Shutter
- 6. IR Camera (Optional)
- 7. IR Camera LEDs (Optional)

Right

- 8. Glass Clickpad
- 9. Power Button Key
- 10. Audio Combo Jack
- 11. SuperSpeed USB Type-A 5Gbps signaling rate (Charging)
- 12. Nano Security Lock Slot (Lock sold separately)
- 13. SIM Card Slot (Optional)
- 14. Touch Fingerprint Sensor (Select models)



Overview



Left

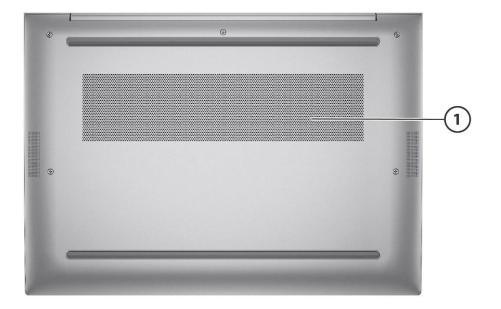
- 1. HDMI 2.0b Port (Cable not included)
- 2. SuperSpeed USB Type-A 5Gbps signaling rate
- 3. Thunderbolt[™] 4* with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)1

*SuperSpeed USB 20Gbps is not available with Thunderbolt[™] 4.

- Thunderbolt[™] 4* with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)1
- 5. LED Indicator
- 6. Smartcard Reader (Optional)



Overview



Bottom

1. Fan Venting



Overview

At A Glance

- Premium ultraslim design with precision-crafted all-metal chassis for a premium look and feel
- Intel[®] Core[™] Ultra5, Ultra7 U series and Intel Core Ultra5, Ultra7 H series Processors up to fourteen-core
- Preinstalled with Windows 11 versions, FreeDOS, or Ubuntu Linux
- Now available paired with Intel Core Ultra5/Ultra7 H series processors and discrete graphics
- 16:10 ratio screen reduces the need to scroll by showing more vertical content than 16:9
- 5MP camera with 88° field of view allows you to move around more freely in front on the camera or accommodate a
 group
- DDR5-5600 memory with up to 64GB capacity
- Choice of displays:
 - o 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit, 300 nits, 45% NTSC
 - o 35.6cm (14") diagonal WUXGA IPS Anti-Glare On-Cell LED-backlit touch, 300 nits, 45% NTSC
 - o 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch 400 nits, 100% sRGB
 - 35.6cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch, 1000 nits, 100% sRGB with HP Sure View Reflect
 - o 35.6cm (14") diagonal WQXGA IPS Anti-Glare LED-backlit non-touch, 500 nits, 100% DCI-P3, DreamColor
- Optional NVIDIA RTX A500 pro graphics for improved performance for heavier graphics workloads.
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.
- Optional 14" DreamColor display for complete color accuracy with a 120Hz refresh rate for smooth motion.
- Connectivity with optional HP 5G/WWAN available world-wide, and Thunderbolt[™] Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests1
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

¹MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled OS

Windows 11 Home 64 - HP recommends Windows 11 Pro for business¹ Windows 11 Home Single Language 64 - HP recommends Windows 11 Pro for business¹ Windows 11 Pro 64(Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement)¹ Windows 11 Pro¹ FreeDOS 3.0 Ubuntu Linux 22.04

¹ Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

Nome123457	Name ^{1,2,3,4,3,7} Cores Threads	Number of Nu	Number Of	Thursda	L3	Max Turbo Frequency		Intel CIDD /// Dro®	
Name		Cache	P-cores	E-cores	SIPP/vPro® Enterprise				
Intel® Core™ Ultra 7 processor 165H	16 cores	6	8	2	22	24 MB	5.00 GHz	3.80 GHz	х
Intel® Core™ Ultra 7 processor 155H	16 cores	6	8	2	22	24 MB	4.80 Ghz	3.80 GHz	
Intel® Core™ Ultra 5 processor 135H	14 cores	4	8	2	18	18 MB	4.60 GHz	3.60 GHz	x
Intel® Core™ Ultra 5 processor 125H	14 cores	4	8	2	18	18 MB	4.50 GHz	3.60 GHz	
Intel® Core™ Ultra 7 processor 165U	12 cores	2	8	2	14	12 MB	4.90 GHz	3.80 GHz	х
Intel® Core™ Ultra 7 processor 155U	12 cores	2	8	2	14	12 MB	4.80 GHz	3.80 GHz	
Intel® Core™ Ultra 5 processor 135U	12 cores	2	8	2	14	12 MB	4.40 Ghz	3.60 GHz	X
Intel® Core™ Ultra 5 processor 125U	12 cores	2	8	2	14	12 MB	4.30 Ghz	3.60 GHz	

PROCESSOR



Features

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

² Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

³ Intel vPro[®] requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro[®] Essentials and Enterprise vary. See http://intel.com/vpro

⁴ In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

⁵ Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

⁷Features and software that require a NPU may require software purchase, subscription or enablement by a software or platform provider, and third party software may have specific configuration or compatibility requirements. Performance varies by use, configuration, and other factors.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel[®] Arc[™] GPU (H Series processors)

Intel[®] Graphics (U Series processors)

Discrete

NVIDIA RTX[™] A500 Laptop GPU (4 GB GDDR6 dedicated)^{1,2}

Supports

Support HD decode, DX12, HDMI 2.0b, HDCP 2.3

¹ Both UMA & Discrete configurations support 4 independent displays when on the HP Thunderbolt Dock G4 (120W) (sold separately) - Max. resolution = 2.5K @60Hz (DP1) & 2.5K @60Hz (DP2) & FHD (VGA) OR 4K @60Hz (one DP Port) & 4K @60Hz (Type-C output port using a Type C-to-DP adapter).

² HDMI cable Sold Separately

DISPLAY

Non-touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-glare, WLED + Low Blue Light, 1000 nits, sRGB 100%, HP Sure View reflect integrated privacy screen^{1,3,4,5}



Features

- 35.6 cm (14") diagonal, WQXGA (2560 x 1600), Bent, LCD, 120Hz, UWVA, anti-glare, WLED, 500 nits, DCI-P3 100%, HP DreamColor^{1,3}
- 35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-glare, WLED + Low Blue Light, 400 nits, low power, sRGB 100%^{1,3}
- 35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-glare, WLED, 300 nits, NTSC 45%^{1,3}
- Touch
- 35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, touch, anti-glare, WLED, 300 nits, NTSC 45%^{1,3,4,5}

DisplayPort™ 1.2

HDMI 2.0 Support resolution up to 4K @60 Hz²

Displays support

Supports dual display through the dock For more information, please reference the following ZBook docking whitepaper: https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA5-2657ENW

Display Size

14" 35.56 cm (14")

¹HD content required to view HD images.
² HDMI cable sold separately.
³Resolutions are dependent upon monitor capability, and resolution and color depth settings.
⁴HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
⁵Actual brightness will be lower with touchscreen or Sure View.



Features

DOCKING	
---------	--

HP Thunderbolt 120W G4 Dock **Docking station model #1** Total number of supported displays (incl.the notebook) 4 display) Max.resolutions supported Quad 4K @60Hz Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode **Dock Connectors** 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode **Technical limitations Thunderbolt Hosts:** Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in High Resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz. **Docking station model #2** HP USB-C Dock G5 Total number of supported displays (incl.the notebook) 3 display) Max.resolutions supported Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) **Dock Connectors** 1xHDMI, 2xDP **Technical limitations** Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port. HP USB-C/A Universal Dock G2 Docking station model #3 Total number of supported displays (incl.the notebook) 3 display) Max.resolutions supported Triple 4K UHD@ 60Hz **Dock Connectors** 1xHDMI, 2xDP **Technical limitations** The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host



Features

STORAGE AND DRIVES*

PCIe[®] NVMe[™] M.2 2280 Storage

2 TB PCIe[®] Gen4x4 NVMe[™] SSD Three Layer Cell 1 TB PCIe[®] Gen4x4 NVMe[™] SSD Three Layer Cell 1 TB PCIe[®] NVMe[™] SSD Value 512 GB PCIe[®] Gen4x4 NVMe[™] Seld Encrypted OPAL2 SSD Three Layer Cell 512 GB PCIe[®] Gen4x4 NVMe[™] SSD Three Layer Cell 512 GB PCIe[®] NVMe[™] SSD Value 256 GB PCIe[®] NVMe[™] Seld Encrypted OPAL2 SSD Value 256 GB PCIe[®] NVMe[™] SSD Value

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

MEMORY

Maximum Memory 64GB DDR5-5600 Memory 64GB DDR5-5600 (2x32GB) 32GB DDR5-5600 (2x16GB) 32GB DDR5-5600 (1x32GB) 16GB DDR5-5600 (1x16GB) 8GB DDR5-5600 (1x8GB)

Memory Slots

2 SODIMM DDR5 SODIMMS, system runs at 5600 Supports Dual Channel Memory

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



Features

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 wireless card vPro WLAN $^{\rm 1,2}$ Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 wireless card WLAN $^{\rm 1}$

¹Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

² Intel vPro[®] requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro[®] Essentials and Enterprise vary. See http://intel.com/vpro

WWAN

HP 5G Sub-6 Cat 19 WWAN eSIM^{1,2} HP 4G LTE-A Pro Cat 16 WWAN eSIM¹

¹WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

²5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

LPWAN

Qualcomm[®] 9205

Near Field Communication (NFC) module

NFC NXP NPC300¹

¹Sold separately or as an optional feature.

Miracast Native Miracast Support

NOTE: Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio Tuning by Poly Studio 2 Integrated stereo speakers Discrete Amplifiers 2 Integrated dual array microphone 3.5mm Headset: CTIA only; Headphone-out

Speaker Power 1W/80hm Per speaker



Features

Camera¹

5MP+Infrared camera 5MP camera

Sensors

ALS (ambient light sensor) ACS (Adaptive Color Sensor) Hall effect Sensor Thermal Sensor HP Tamper Lock²

¹ Sold separately or as an optional feature.
 ² HP Tamper Lock must be enabled by the customer or your administrator.



Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard*

HP Premium Keyboard, spill-resistant, Privacy, Backlit, Durakey keyboard. HP Premium Keyboard, spill-resistant, Backlit, Durakey keyboard. HP Premium Keyboard, spill-resistant, Durakey keyboard.

Pointing Devices

Clickpad with multi-touch gesture support Microsoft Precision Touchpad Default Gestures Support Multi-touch gesture support

Function Keys

ESC: system information F1 - Display Switching F2 - Blank or Privacy F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute F6 - Volume Down F7 - Volume Up F8 - Mic Mute F9 - Blank or Backlit Toggle F10 - Insert F11 - Airplane Mode F12 - HP Command Center home end Power Button (with LED) Delete Microsoft Copilot key** **Hidden Keys** Fn+R - Break Fn+S - Svs Ra Fn+C - Scroll Lock

*Backlit keyboard is an optional feature.

**Requires Windows 11 and an NPU. Timing of feature delivery and availability varies by market and device. Requires Microsoft account to log in. Where Copilot in Windows is not available, the Copilot key will lead to the Bing search engine. See http://aka.ms/WindowsAIFeatures

SOFTWARE AND SECURITY

Software

Bing Search for IE11 Buy Microsoft Office (Sold separately) HP Connection Optimizer¹⁰ HP Easy Clean² HP Easy Clean Keyboard Driver² HP Hotkey Support HP Mac Address Manager HP Notifications HP PC Hardware Diagnostics UEFI HP PC Hardware Diagnostics Windows HP Privacy Settings HP Support Assistant¹



Features

HSA Fusion for Commercial HPX for CMIT

Manageability Features

HP Client Catalog (download) HP Client Management Script Library (download) HP Cloud Recovery²⁸ HP Connect for Microsoft Endpoint Manager²⁶ HP Driver Packs (download) HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)¹² HP Patch Assistant (download)²⁷

Security Management

HP Wolf Security of Business²⁹ includes: HP Client Catalog (download) HP Client Management Script Library (download) HP Cloud Recovery²⁸ HP Connect for Microsoft Endpoint Manager²⁶ HP Driver Packs (download) HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)¹² HP Patch Assistant (download)²⁷

Security- TPM

TCG TPM 2.0 **BIOS** Absolute Persistence Module⁷ BIOS Update via Network HP BIOSphere Gen6⁶ HP DriveLock & Automatic DriveLock HP Fingerprint Sensor³² HP Secure Erase¹⁷ HP Wake on WLAN

¹ HP Support Assistant - Requires Windows and Internet Access.

²HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.

⁶ HP BIOSphere Gen6 is available on select HP Pro, Elite and ZBook PCs. See product specifications for details. Features may vary depending on the platform and configurations.

⁷ Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software. ¹⁰ HP Connection Optimizer requires Windows 10 and Windows 11.

¹² HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPMIK.html.

¹⁷ HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

²⁶ HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.
²⁷ HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

hp)

Features

²⁸ HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel[®] or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

²⁹ HP Wolf Security for Business requires Windows 10 Pro or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

³² HP Fingerprint Reader is an optional feature that requires Windows 10 IoT and must be configured at purchase.

Features

POWER

Power Supply

HP Standard 65W USB Type-C[®] adapter² HP Slim 65W USB Type-C[®] adapter² HP Slim 100W USB Type-C[®] AC adapter²

Battery

HP Long Life 3-cell, 56 Whr Polymer^{3,4}

Power Cord 3-wire plug - 1m 2-wire plug - 1m

Battery life UMA TBD¹

Discrete TBD¹

¹ MM25 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

² Availability may vary by country.

³Battery is internal and not replaceable by customer. Serviceable by warranty.

⁴ Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.



Features

WEIGHTS & DIMENSIONS

Dimensions (w x d x h) 12.42 x 8.82 x 0.76 in 31.56 x 22.435 x 1.92 cm

Weights* Product Weight- 56Whr Starting at 3.14 lb Starting at 1.42 kg

*Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

Left side

2 Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4) *

- 1 HDMI 2.1**
- 1 Super Speed USB Type-A 5Gbps signaling rate
- 1 Smartcard reader

Right side

- 1 Headphone/microphone combo jack
- 1 Nano SIM card slot
- 1 Super Speed USB Type-A 5Gbps signaling rate
- 1 Security Lock Slot

*SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4. **HDMI cable sold separately.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty.. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

¹HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Certification and Compliance

CSA/UL 62368-1
ENERGY STAR®
FCC/ICES/CISPR/VCCI
CE MARKING
GS Mark



Features

China CCC/SRRC Taiwan BSMI/NCC Korea KCC/KC/KES Ukraine NSoC/TEC EAEU Compliance Saudi Arabian Compliance TCO EPEAT® registered* Low Blue Light WW RoHS

Sustainable Impact Specifications

Low Halogen** aligned with HP GSE

*Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit www.epeat.net for more information

**External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

SYSTEM UNIT

Requirements (AC Power)VoltageAverage Operating Power(idle)Average Operating Power(idle)Integrated graphicsYesDiscrete GraphicsN/AMax Operating Power65WTemperatureOperatingOperating32° to 95° F (0° to 35° C)Relative HumidityOperatingIntegrated graphics10% to 90%, non-condensing
Discrete GraphicsN/AMax Operating Power65WTemperatureOperatingNon-operating-4° to 140° F (-20° to 60° C)
Max Operating Power 65W Temperature Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)
Temperature Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)
Non-operating -4° to 140° F (-20° to 60° C)
Relative Humidity Operating 10% to 90%, non-condensing
Non-operating 5% to 95% (38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)
Shock Operating 40 G, 2 ms, half-sine
Non-operating 240 G, 2 ms, half-sine
Random Vibration Operating 1.043 grms
Non-operating 3.5 grms
Maximum AltitudeOperating10,000 ft (3,048 m)
(unpressurized) Non-operating 40,000 ft (12,192 m)
Planned Industry Standard Regulatory Model HSN-145C-4 Certifications Number
CSA/UL 62368-1 Yes
ENERGY STAR®1 Yes
FCC/ICES/CISPR/VCCI Yes
CE MARKING Yes
GS Mark Yes
China CCC/SRRC Yes
Taiwan BSMI/NCC Yes
Korea KCC/KC/KES Yes



Features

Ukraine NSoC/TEC	Yes
EAEU Compliance	Yes
Saudi Arabian	Vez
Compliance	Yes
TCO	Yes
EPEAT®	EPEAT [®] Gold in the United States ²
Low Blue Light	Yes
WW RoHS	Yes
Saudi Arabian	
Compliance (ICCP)	Yes
SABS	Yes

¹Configurations of the HP ZBook Firefly 14" G11 Mobile Workstation PC that are ENERGY STAR[®] qualified are identified as HP ZBook Firefly 14" G11 Mobile Workstation PC ENERGY STAR on HP websites and on http://www.energystar.gov. ²Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. Status varies by country. Visit www.epeat.net for more information.



Technical Specifications – Displays

DISPLAYS

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC 45 NB2X 300 eDP 1.2 w/o PSR bent LCD Panel

Outline Dimensions (W × H)	307.29 x 199.25 (max)	
Active Area	301.59 X 188.50 (typ)	
Weight	300 (max)	
Diagonal Size	14	
Thickness	3.0 / 4.8 (max)	
Interface	eDP 1.2	
Surface Treatment	Anti-Glare	
Touch enabled	No	
Contrast Ratio	1000:1(typ)	
Refresh Rate	60 Hz	
Brightness	300 nits	
Pixel Resolution	Pitch	1920 x 1200 (WUXGA)
	Format	RGB
Backlight	WLED	
Color Gamut Coverage	NTSC 45%	
Color Depth	6+2 FRC	
Viewing Angle	UWVA 89/89/89/89	
Low Blue Light	No	
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.20 (max) / 2.70 (max)
111a <i>x)</i>	2.20 (IIIdx) / 2.70 (IIIdx	.)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC 45 NB2X 300 TOP eDP 1.2 w/o PSR bent LCD PanelOutline Dimensions (W × 1 Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch enabled Contrast Ratio		301.59 x 188.50 (typ) 305g (max) 14 3.0 / 5.0 (max) eDP 1.2 Anti-Glare Yes 1000:1(typ)		
	Refresh Rate Brightness Pixel Resolution Backlight Color Gamut Coverage Color Depth Viewing Angle Low Blue Light	60 Hz 300 nits Pitch Format WLED NTSC 45% 6+2 FRC UWVA 89/89/89/89 No	1920 x 1200 (WUXGA) RGB	



Technical Specifications – Displays

Power Consumption (W, EBL@ 150nits max/ 200nits max)

2.15 (max)/2.65 (max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

Outline Dimensions (W × H)	307.590 x 199.550 (max	x)	
Active Area	301.590 X 188.500 (typ)		
Weight	210 (max)		
Diagonal Size	14		
Thickness	2.0 / 3.8 (max)		
Interface	eDP 1.4		
Surface Treatment	Anti-Glare		
Touch enabled	No		
Contrast Ratio	1000:1(typ)		
Refresh Rate	60 Hz		
Brightness	400 nits		
Pixel Resolution	Pitch	1920 x 1200 (WUXGA)	
	Format	RGB	
Backlight	WLED		
Color Gamut Coverage	sRGB 100%		
Color Depth	8 bits		
Viewing Angle	UWVA 89/89/89/89		
Low Blue Light	Yes		
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.29 (max) / 1.66 (max)		

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD	Outline Dimensions (W x H)	307.600 x 199.550 (typ	b)	
	Active Area	301.680 x 188.500 (typ	b)	
	Weight	238 (max)		
	Diagonal Size	14		
Panel	Thickness	2.2 / 3.9 (max)		
	Interface	eDP 1.3		
	Surface Treatment	Anti-Glare		
	Touch Enabled	No		
	Contrast Ratio	1500:1(typ)		
	Refresh Rate	60 Hz		
	Brightness	1000 nits		
	Pixel Resolution	Pitch	1920 x 1200 (WUXGA)	
		Format	RGB	



Technical Specifications – Displays

Backlight	WLED
Color Gamut Coverage	sRGB 100%
Color Depth	8 bits
Viewing Angle	UWVA 85/85/85/85
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	N/A

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

-	Outline Dimensions (W x H)	307.594 x 199.546 (ma	x)	
1600) Anti-Glare UWVA LED DCI-P3 NB2X 500 eDP 1.4+PSR2 100 120Hz bent LCD Panel	Active Area	301.594 x 188.496 (typ)	
	Weight	230 (max)		
	Diagonal Size	14		
	Thickness	2.0 / 3.8 (max)		
	Interface	eDP 1.4		
	Surface Treatment	Anti-Glare		
	Touch Enabled	No		
	Contrast Ratio	1200:1(typ)		
	Refresh Rate	120 Hz		
	Brightness	500 nits		
	Pixel Resolution	Pitch	2560 x1600 (WQXGA)	
		Format	RGB	
	Backlight	WLED		
	Color Gamut Coverage	DCI-P3 100%		
	Color Depth	8 bits		
	Viewing Angle	UWVA 89/89/89		
	Low Blue Light	No		
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.88 (max) / 3.44 (max)		
	*All specifications represent t	he tubical considirations	provided by HD's sempon	

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



Technical Specifications – Storage

STORAGE AND DRIVES

SSD 512GB 2280 PCIe- 4x4 NVMe Three Layer	Form Factor	M.2 2280				
Cell	Capacity	512GB				
	NAND Type	TLC				
	Height	0.09 in (2.3 mm)				
	Width	0.87 in (22 mm)				
	Weight	0.02 lb (10 g)				
	Interface	PCIe NVMe Gen4X4				
	Performance	Minimum Sequential Read	Minimum Sequential Write			
		6400 MB/s ±20%	3500 MB/s ±20%			
	Logical Blocks	1,000,215,215				
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	vient temp]			
	Features	Pyrite 2.0; TRIM; L1.2				
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for			
SSD 1TB 2280 PCIe-4x4	Form Factor	M.2 2280				
NVMe Three Layer Cell	Capacity	1TB				
	NAND Type	TLC				
	Height	0.09 in (2.3 mm)				
	Width	0.87 in (22 mm)				
	Weight	0.02 lb (10 g)				
	Interface	PCIe NVMe Gen4X4				
	Performance	Minimum Sequential Read	Minimum Sequential Write			
		6400 MB/s ±20%	5000 MB/s ±20%			
	Logical Blocks	2,000,409,264				
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	vient temp]			
	Features	Pyrite 2.0; TRIM; L1.2				
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for			
SSD 2TB 2280 PCIe-4x4	Form Factor	M.2 2280				
NVMe Three Layer Cell	Capacity	2TB				
	NAND Type	TLC				
	Height	0.09 in (2.3 mm)				
	Width	0.87 in (22 mm)				
	Weight	0.02 lb (10 g)				
	Interface	PCIe NVMe Gen4X4				
	Performance	Minimum Sequential Read	Minimum Sequential Write			
		- 6400 MB/s ±20%	5000 MB/s ±20%			
	Logical Blocks	4,000,797,360				
	Operating Temperature					
	Features	Pyrite 2.0; TRIM; L1.2	• -			



Technical Specifications – Storage

			= 1 billion bytes. TB = 1 trillion bytes. Actual
		formatted capacity is less. Up system recovery software.	to 35 GB (for Windows 11) is reserved for
	Form Factor	M.2 2280	
256GB PCIe 2280 NVMe Self Encrypted OPAL2			
Value Solid State Drive	Capacity	256GB	
	NAND Type	TLC	
	Height Width	0.09 in (2.3 mm) 0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
	renonmance	2000 MB/s ±20%	900 MB/s ±20%
	Logical Blocks	500,118,192	500 MB/S ±20%
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	iont tomp]
	Features	TCG Opal 2.0; TRIM; L1.2	
	reatures	• • •	= 1 billion bytes. TB = 1 trillion bytes. Actual
		.	to 35 GB (for Windows 11) is reserved for
512GB PCIe-4x4 2280	Form Factor	M.2 2280	
NVME Self Encrypted	Capacity	512GB	
OPAL2 Three Layer Cell Solid State Drive	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
		6400 MB/s ±20%	3500 MB/s ±20%
	Logical Blocks	1,000,215,215	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]
	Features	TCG Opal 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for
SSD 1TB 2280 PCIe NVMe	Form Factor	M.2 2280	
Value	Capacity	1TB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
		2200 MB/s ±20%	1600 MB/s ±20%
	Logical Blocks	2,000,409,264	· · · · ·
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]
	Features	Pyrite 2.0; TRIM; L1.2	



Technical Specifications – Storage

			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for
SSD 256GB 2280 PCIe	Form Factor	M.2 2280	
NVMe Value	Capacity	256 GB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
		2000 MB/s ±20%	900 MB/s ±20%
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	pient temp]
	Features	Pyrite 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for
SSD 512GB 2280 PCIe	Form Factor	M.2 2280	
NVMe Value	Capacity	512 GB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
		2200 MB/s ±20%	1000 MB/s ±20%
	Logical Blocks	1,000,215,215	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	pient temp]
	Features	Pyrite 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 11) is reserved for



Technical Specifications – Networking

NETWORKING/COMMUNICATION

Intel® AX211 Wi-Fi 6E +Bluetooth® 5.3 wireless card M.2 160MHz CNVi World-wide WLAN vPro® 1		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 - 2.482 GHz 802.11a/n/ac/ax • 4.9 - 4.95 GHz (Japan) • 5.15 - 5.25 GHz • 5.25 - 5.35 GHz • 5.47 - 5.725 GHz • 5.825 - 5.850 GHz • 5.955 - 6.415 GHz • 6.435 - 6.515 GHz • 6.535 - 6.875 GHz • 6.895 - 7.115 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac : 1733Mbps 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum
		OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
	Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer)
	- .	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points



Output Power² • 802.11b : +17dBm minimum • 802.11a : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +14dBm minimum • 802.11n HT40(5GHz) : +13dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum • 802.11ax HE80(5GHz) : +10dBm minimum • 802.11ax HE160(5GHz) : +10dBm minimum **Power Consumption** Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10mW Radio disabled 8 mW **Power Management** ACPI and PCI Express compliant power management 802.11 compliant power saving mode **Receiver Sensitivity³** •802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/q, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0(VHT80) : -84dBm maximum • 802.11ac, MCS9(VHT80) : -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum •802.11ax, MCS11(HE40): -57dBm maximum •802.11ax. MCS11(HE80): -54dBm maximum •802.11ax, MCS11(HE160): -53.5dBm maximum High efficiency antenna with spatial diversity, mounted in the Antenna Type display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications **Form Factor** PCI-Express M.2 MiniCard Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm Weight 1. Type 2230 : 2.8q 2. Type 1216: 1.3g **Operating Voltage** 3.3v +/- 9% Temperature Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) Humidity Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing) Altitude Operating Non-0 to 10,000 ft (3,048 m) operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio Off; LED Off – Radio ON

Technical Specifications – Networking

Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbp voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR an EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	Bluetooth® 4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan Bluetooth® 4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Bluetooth®- 5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Bluetooth® 5.3 Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Sectipn 12.3 of Bluetooth® 5.3 wireless card specification

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 wireless card M.2 160MHz CNVi World-wide WLAN nonvPro ® Wireless Card1	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ac IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11v
	Interoperability Frequency Band	Wi-Fi certified 802.11b/g/n/ax • 2.402 – 2.482 GHz 802.11a/n/ac/ax • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.825 – 5.850 GHz • 5.955 – 6.415 GHz • 6.435 – 6.515 GHz • 6.535 – 6.875 GHz
	Data Rates	 6.895 – 7.115 GHz 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac : 1733Mbps 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security ¹	, 1024QAM • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.



Technical Specifications – Networking

	 WPA2 certification WPA3 certification IEEE 802.11i WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	 802.11b : +17dBm minimum 802.11g : +16dBm minimum 802.11a : +17dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT20(5GHz) : +14dBm minimum 802.11n HT40(5GHz) : +13dBm minimum 802.11ac VHT80(5GHz) : +10dBm minimum 802.11ax HE40(2.4GHz) : +12dBm minimum 802.11ax HE80(5GHz) : +10dBm minimum 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	 Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10mW Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³ Antenna Type	 802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11a, g, 54Mbps : -67dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11ac, MCS0(VHT80) : -84dBm maximum 802.11ac, MCS9(VHT80) : -59dBm maximum 802.11ac, MCS9(VHT160) : -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE60): -53.5dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum
	display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g
Operating Voltage	3.3v +/- 9%



Technical Specifications – Networking

5		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non- operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OF	FF; LED White – Radio ON
HP Integrated Module with Bluete	ooth 4.0/4.1/4.2/5.0/5	.1/5.2/5.3 Wireless Technology
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/ BLE : 0~39 (2 MHz/CH	
Data Rates and Throughput	BLE : 1 Mbps data rate Legacy : Synchronous voice channels Legacy : Asynchronou	rate; throughput up to 2.17 Mbps e; throughput up to 0.2 Mbps Connection Oriented links up to 3, 64 kbps, as Connection Less links 2178.1 kbps/177.1 DH5) or 864 kbps symmetric (3-EV5)
Transmit Power		nent shall operate as a Class II Bluetooth m transmit power of + 9.5 dBm for BR and
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17	′ mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bl	uetooth Software
Power Management	Microsoft Windows AC	CPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C	, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 Low Voltage Directive UL, CSA, and CE Mark	
Bluetooth Profiles Supported	Bluetooth® 4.1-ESR 5 LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Dir LE L2CAP Connection Train Nudging & Inter Bluetooth® 4.2 ESR08 LE Secure Connection LE Privacy 1.2 –Link L LE Privacy 1.2 –Exten LE Data Packet Lengtl FAX Profile (FAX) Basic Imaging Profile Headset Profile (HSP) Hands Free Profile (HISP) Hands Free Profile (HISP) Bluetooth® 5.2	ected Advertising Oriented Channels laced Scan Compliance - Basic/Full ayer Privacy ded Scanner Filter Policies h Extension (BIP)2 FP)



ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Bluetooth® 5.3 Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Sectipn 12.3 of Bluetooth® 5.3 wireless card specification

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP 5G Sub-6 Cat 19 WWAN eSIM

Technology/Operating	WCDMA/HSPA+ operating bands:
bands*	Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
	Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
	Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
	Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
	Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
	LTE FDD/TDD operating bands:
	Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
	Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
	Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
	Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
	Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
	Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
	Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
	Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)
	Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)
	Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)
	Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)
	Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)
	Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)
	Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
	Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
	Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)
	Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
	Band 29: 717 to 728 MHz (DL)
	Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)
	Band 32: 1452 to 1496 MHz (DL)
	Band 34: 2010 to 2025 MHz (UL/DL)
	Band 38: 2570 to 2620 MHz (UL/DL)
	Band 39: 1880 to 1920 MHz (UL/DL)



	Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 46: 5150 to 5925 MHZ (UL), 2110 to 2200 MHz (DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) 5GNR Sub 6GHZ n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 791 to 821 MHz (DL) n20: 832 to 862 MHz (UL), 1930 to 1995 MHz (DL) n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) n30: 2305 to 2315 MHz (UL), 2550 to 2360 MHz (DL) n38: 2570 to 2620 MHz (UL/DL) n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n71: 663 to 698 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 100 to 1995 MHz (DL) n71: 663 to 698 MHz (UL/DL) n71: 663 to 698 MHz (UL/DL) n71: 663 to 698 MHz (UL/DL) n77: 3300 to 4200 MHz (UL/DL) n77: 3300 to 4200 MHz (UL/DL) n77: 3300 to 3800 MHz (UL/DL)
Wireless protocol standards	NR Sub6G rel15 200MHz 2 DLCA, 256 QAM 200MHz 2 ULCA, 256 QAM 15KHz/30KHz SCS for FDD/TDD LTE Rel15 100MHz 5 DLCA, 256 QAM 40MHz 2 ULCA, 256 QAM UMTS Rel8
GPS GPS bands	GPS only support L1 C/A GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)
Maximum data rates	Sub-6 SA Peak DL 4.67Gbps/UL 1.25Gbps Sub-6 NSA Peak DL 3.74Gbps/UL 835Mbps LTE Peak DL 1.6Gbps (CAT19)/UL 211Mbps (CAT18) UMTS/HSPA+ DL DC-HSPA+: 42 Mbps (CAT24)/UL 11.5 Mbps (CAT7)
Maximum output power	NR: 23 dBm in all band except (n30 = 22dBm & n48=21dBm & n77=25dBm & n41/n77/n78 = 26dBm) LTE:



Technical Specifications – Networking

	23 dBm in all band except (B30 = 22dBm & B48=21dBm & B41=26dBm) UMTS: 23.5 dBm
Maximum power consumption	3500 mA (peak); 1674mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	8.7g
Dimensions (Length x Width x Thickness)	52 mm × 30 mm × 2.3 mm

embedded eSIM

Support

*5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

HP 4G LTE-A Pro Cat16 WWAN eSIM

Technology/Operating bands*	WCDMA/HSPA+ operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) LTE FDD/TDD operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 5: 824 to 849 MHz (UL), 2620 to 2690 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 729 to 746 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 734 to 746 MHz (DL) Band 14: 788 to 798 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 26: 814 to 849 MHz (UL), 758 to 768 MHz (DL) Band 20: 832 to 716 MHz (UL), 751 to 746 MHz (DL) Band 20: 832 to 862 MHz (UL), 751 to 830 MHz (DL) Band 26: 814 to 849 MHz (UL), 755 to 890 MHz (DL) Band 26: 814 to 849 MHz (UL), 755 to 800 MHz (DL) Band 26: 814 to 849 MHz (UL), 755 to 800 MHz (DL) Band 26: 814 to 849 MHz (UL), 755 to 800 MHz (DL) Band 26: 717 to 728 MHz (UL), 755 to 803 MHz (DL) Band 26: 717 to 728 MHz (DL) Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL) Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL)/DL) Band 34: 2010 to 2025 MHz (UL/DL)



Wireless protocol standards	Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 48: 3550 to 3700 MHZ (UL/DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) 3GPP LTE Rel15 LTE Specification, 100MHz 5 DLCA, 256 QAM, DL 1.0Gbps (CAT16)/ 40MHz 2 ULCA, 256 QAM, UL 211Mbps (CAT18) WCDMA 3GPP Release 8 UMTS Specification, DL UMTS: 384 kbps/UL 384 kbp, DL DC-HSPA+: 42 Mbps (CAT24)/UL 11.5 Mbps (CAT7) WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS Bands	GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)
Maximum Data Rates	LTE: ue-CategoryDL 16, (DL : 1 Gbps) ue-CategoryUL 18 , (UL: 211Mbps) DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)
Maximum Output Power	HPUE: Not supported LTE: 23 dBm in all band except (B30= 22dBm& B48= 21dBm) UMTS: 23.5 dBm
Maximum Power Consumption	LTE: 1300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3052-S3 Key B
Weight	8 g
Dimensions (Length x Width x Thickness)	52 mm × 30 mm × 2.3 mm
eSIM	Support

*Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

NFC NXP NPC300

Dimensions (L x W	
x H)	17 x 10 x 2.0 mm
Chipset	NPC300
System interface	12C
NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2



	Reader (PCD-VCD) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz ca	ards	
	Card Emulation (PICC- VICC) Mode(1)	ISO/IEC 14443 A ISO/IEC 14443 B an MIFARE FeliCa	ıd B'	
	Frequency	13.56 MHz		
	NFC Modes Supported	Reader/Writer, Peer-to-Peer 106, 212, 424, 848 kbps		
	Raw RF Data Rates			
	Operating			
	temperature	0°C to 70°C		
	Storage temperature			
	Humidity	10-90% operating 5-95% non-operat	ing	
	Supply Operating voltage	4.35 to 5.25 Volts	5	
	I/O Voltage	1.8V or 3.3V		
	Power Consumption	Booster enable,	VBAT= 3.3V,	
		VCC_BOOST = 5V)	Polling	7.3 mA
		Mode Power Consumption,	Detected Test Tag Type 1	Total 283.8 mA Net Module 236.8 mA
		Typical	Detected Test Tag Type 2	Total 288.8 mA Net Module 241.8 mA
			Detected Test Tag Type 3	Total 287.7 mA Net Module 240.7 mA
			Detected Test Tag Type 4	Total 282.3 mA Net Module 235.3 mA
	Antenna	Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module.		
Qualcomm [®] 9205				
Technology/Operating bands*	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 800 (Band 27), 700 (Band 28), 1700/2100 (Band 66), 700 (band 85) MHz. GSM/GPRS/EGPRS: 850, 900, 1800, 1900MHz.			
Wireless protocol standards	 3GPP TS 51.010-1 V10.5.0: Mobile Station (MS) conformance specification; Part 1: Conformance specification 3GPP TS 36.521-1 V14.3.0: User Equipment (UE) conformance specification; Radio transmission and reception; Part 1: Conformance testing 3GPP TS 21.111 V10.0.0: USIM and IC card requirements 3GPP TS 51.011 V4.15.0: Specification of the Subscriber Identity Module -Mobile Equipment (SIM-ME) interface 3GPP TS 31.102 V10.11.0: Characteristics of the Universal Subscriber 			



	Identity Module (USIM) application • 3GPP TS 31.11 V10.16.0: Universal Subscriber Identity Module (USIM) Application Toolkit (USAT) • 3GPP TS 36.124 V10.3.0: Electro Magnetic Compatibility (EMC) requirements for mobile terminals and ancillary equipment • 3GPP TS 27.007 V10.0.8: AT command set for User Equipment (UE) • 3GPP TS 27.005 V10.0.1: Use of Data Terminal Equipment - Data Circuit terminating Equipment (DTE - DCE) interface for Short Message Service (SMS) and Cell Broadcast Service (CBS)
GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
GPS Bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
Maximum Data Rates	LTE FDD: 375 Kbps (Download), 1119 Kbps (Upload) GSM: - GPRS: 107 Kbps (Download), 85.6 Kbps (Upload) - EGPRS: 296 Kbps (Download), 236.8 Kbps (Upload)
Maximum Output Power	LTE: 21.5 dBm in all band GSM:34dBm
Maximum Power Consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 2242-S3 Key B
Weight	5.5 g
Dimensions (Length x Width x Thickness)	22 x 42 x 2.3 mm
eSIM	Support

11. LPWAN (also called Mobile Narrowband) does not support mobile broadband use.

AUDIO

HD Stereo Codec Audio I/O Ports	Realtek ALC3315 Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	Cirrus Logic High-Efficiency Boosted Class D Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio. Following MSFT Behaviour
Sampling	DAC:48kHz ADC:48kHz
Wavetable Syntheses	N/A
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line- Out	N/A
Internal Speaker	Yes

FINGERPRINT READER



Technical Specifications – Networking

Sensor vendor	Synaptics
Sensor type	Capacitive
DPI resolution	363 DPI
Scan area	104 x 86 pixels
False Rejection Rate	FRR=≤ 3%
False Acceptance Rate	FAR 1/100K
Mobile Voltage Operation	a 3.0V to 3.6V
Operating Temperature	0~60C
Current Consumption	100mA max
Image	
Low Latency Wait For	260uA
Finger Contours Data	
Capture Rate	50 Frames/ sec
ESD Resistance	IEC 61000-4-2 4B (+15KV)
Detection Matrix	363 dpi / 7.4x6mm sensor area
Sensor vendor	Elan
Sensor vendor Sensor type	Elan Capacitive
Sensor type	Capacitive
Sensor type DPI resolution	Capacitive 508 DPI
Sensor type DPI resolution Scan area	Capacitive 508 DPI 80 x 80 pixels
Sensor type DPI resolution Scan area False Rejection Rate	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 2.7V to 3.6V
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 1 2.7V to 3.6V -20~80C
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image Low Latency Wait For	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 1 2.7V to 3.6V -20~80C
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image Low Latency Wait For Finger	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 2.7V to 3.6V -20~80C 35mA max 300uA
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image Low Latency Wait For Finger Capture Rate	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 2.7V to 3.6V -20~80C 35mA max 300uA 50 Frames/ sec
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image Low Latency Wait For Finger Capture Rate ESD Resistance	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 2.7V to 3.6V -20~80C 35mA max 300uA 50 Frames/ sec IEC 61000-4-2 4B (+15KV)
Sensor type DPI resolution Scan area False Rejection Rate False Acceptance Rate Mobile Voltage Operation Operating Temperature Current Consumption Image Low Latency Wait For Finger Capture Rate	Capacitive 508 DPI 80 x 80 pixels FRR=≤ 3% FAR 1/100K 2.7V to 3.6V -20~80C 35mA max 300uA 50 Frames/ sec

POWER

AC Adapter 65 Watt nPFC Standard USB type C	Dimensions Weight	3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm) 240g ±10g		
Straight 1.8m	Input	Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V	
		Input frequency range	47 ~ 63 Hz	
		Input AC current	Max. 1.6 A at 90 Vac	
	Output	Output power	5V/15W 9V/27W 12V/60W 15V/65W	



Technical Specifications – Networking

			20V/65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	100% load 5ms at 115 Vac input
		Output current limit	<8.0A
		AC Inlet Type	C6
		DC Cable Connector	USB type C
		DC Cable Material	PVC
	Connector	C6	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar EN62368-1:2014+A11, UL Agency approvals - C-UL-I B, CISPR32 Class B, CCC an	JS, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class Id CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K- NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-
HP 65W Slim USB-C	Dimensions	3.819 x 2.106 x 0.827 in (9.7x5.35x2.1cm)
Straight AC Power Adapter	Weight	220g ±10g	
nuuptei	Input	Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
		Input frequency range	47-63Hz
		Input AC current	Max. 1.6 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/60W 15V/65W 20V/65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	100% load 5ms at 115 Vac input
		Output current limit	< 8.0A
		AC Inlet Type	C6
		DC Cable Connector	USB type C
		DC Cable Material	PVC
	Connector	C6	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)



Technical Specifications – Networking

		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity Store on Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar EN62368-1:2014+A11, UL Agency approvals - C-UL-I B, CISPR32 Class B, CCC an	US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class nd CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K- NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-
HP 100W Slim USB-C	Dimensions	5.354 x 2.362 x 0.866 in ([*]	13.6x6.0x2.2cm)
Straight AC Power	Weight	380g ± 10g	
Adapter	Input	Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V
	mput	input Lincicity	86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
		Input frequency range	47-63Hz
		Input AC current	Max. 1.6 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/60W 15V/75W 20V/100W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
		Output current limit	5V/9V/12V/15V<125% max current, 20V<135% max current
		AC Inlet Type	C6
		DC Cable Connector	USB type C
		DC Cable Material	PVC
	Connector	C6	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar IEC62368-1 : 2018, EN623 Agency approvals - C-UL-I B, CISPR32 Class B, CCC, C	with LVD and EMC directives ds - IEC60950-1, IEC 62368-1:2014 and 368-1:2020+A11, UL 62368-1 US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class U(EAC), KCC(Safety+EMC), NOM-001 NYCE, NRcan, ntina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA pHS+ECO)



Technical Specifications – Networking

HP 3-cell Long Life Li-Ion Dimensions (H x W x L)		251.8*70.3*6.82mm (9.91*2.77*0.27 inch)		
(56 WHr)	Weight	0.205kg +/- 10g(0.474 lb)	10g(0.474 lb)	
	Cells/Type	3cell Lithium-Ion Polymer	cell / 586075	
	Energy	Voltage	11.58V	
		Amp-hour capacity	4.84Ah	
		Watt-hour capacity	56.04Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (-10° to 60° C)	
	Fuel Gauge LED	NA		
	Warranty	Follow product spec		
	Optional Travel Battery Available	No		
	decrease with shelf life, tir		capacity. Battery capacity will naturally nperature, system configuration, loaded apps, ors.	

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] US Federal Energy Management Program (FEMP) EPEAT^O Gold registered in the United States. See http://www.epeat.net for registration status in your country. TCO Certified China Energy Conservation Program (CECP) China State Environmental Protection Administration (SEPA) Taiwan Green Mark Korea Eco-label Japan PC Green label*
Sustainable Impact Specifications	 Product Carbon Footprint (hp.com) Ocean-bound plastic in Speaker
	• 60% post-consumer recycled plastic
	• 65% recycled metal • Low halogen
	 Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
	 Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".
Energy Consumption	

(in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	5.88 W	6.17 W	5.92 W
Normal Operation (Long idle)	1.66 W	1.85 W	1.76 W
Sleep	1.66 W	1.85 W	1.76 W
Off	0.46 W	0.48 W	0.41 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	20.1 BTU/hr	21.1 BTU/hr	20.2 BTU/hr
Normal Operation (Long idle)	5.7 BTU/hr	6.3 BTU/hr	6.0 BTU/hr
Sleep	5.7 BTU/hr	6.3 BTU/hr	6.0 BTU/hr
Off	1.6 BTU/hr	1.6 BTU/hr	1.4 BTU/hr



***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (L _{wad} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle		3.1	20.6
Fixed Disk – Random writes		3.3	22.8
Optical Drive – Sequential reads		4.0	31.5
Longevity and Upgrading		n be upgraded, possibly extending its u components contained in the	iseful life by several years. Upgradeable
	Spare parts are of production.	available throughout the warranty per	iod and or for up to "5" years after the end
Additional Information	directiv This HF Equipm This pr Drinkin This pr www.e Plastic and ISC	ve – 2011/65/EC. P product is designed to comply with the nent (WEEE) Directive – 2002/96/EC. oduct is in compliance with California F og Water and Toxic Enforcement Act of oduct is in compliance with the IEEE 16 peat.net s parts weighing over 25 grams used ir	Proposition 65 (State of California; Safe 1986). 680 (EPEAT) standard at the Gold level, see 1 the product are marked per ISO11469
Packaging Materials	External:	PAPER/Corrugated	220 g
		PAPER/Corrugated	49 g
		PAPER/Molded Pulp	52 g
		PAPER/Molded Pulp	56 g
		PAPER/Paper	3 g
	Internal:	PLASTIC/Polyethylene low density -	LDPE 13 g
	The plastic pac	kaging material contains at least 0.0%	recycled content.
	The corrugated	l paper packaging materials contains a	t least 59.1% recycled content.
RoHS Compliance	the restrictions to our products		
	wide elimination substances—in	RoHS directive and similar laws play an n of substances of concern. We have su cluding PVC, BFRs, and certain phthala trical and electronics products.	
	requirements fo		compliance with the new EU RoHS y 2013, and we will continue to extend the substances as regulations continue to



To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
 - Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and
RecyclingHP offers end-of-life HP product return and recycling programs in many geographic areas. To
recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest
HP sales office. Products returned to HP will be recycled, recovered or disposed of in a
responsible manner.



	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:
	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842
	and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
Footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. Plastic cushions are made from >90% recycled plastic.

QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Audio/Video	HP USB G2 Stereo Headset	428H5AA
	HP USB G2 Stereo Headset	428K6AA
	HP 3.5mm G2 Stereo Headset	428H6AA
	HP 3.5mm G2 Stereo Headset	428K7AA
	HP 365 BT Speaker	567D3AA
	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K Streaming Webcam	695J5AA
	HP 625 FHD Webcam	6Y7L1AA
Cases	HP Prelude 15.6 Backpack (Bulk Qty.15)	1E7D6A6
	HP Prelude Pro Recycle Backpack	1X644AA
	HP Prelude Pro Recycle Top Load	1X645AA
	HP Prelude 15.6 Top Load	1E7D7AA
	HP Prelude 15.6 Top Load	2Z8P4AA
	HP Prelude 15.6 Top Load	50P31AA
	HP Prelude 15.6 Backpack	1E7D6AA
	HP Prelude 15.6 Backpack	2Z8P3AA
	HP Prelude 15.6 Backpack	50P32AA
	HP Prelude Pro Recycled 15.6 Backpack (Bulk Qty.12)	1X644A6
	HP Prelude Pro Recycled 15.6 Top Load (Bulk Qty.12)	1X645A6
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack (Bulk Qty. 6)	3E2U5A6
	HP Renew Business 15.6 Laptop Bag (Bulk Qty.12)	3E5F8A6
	HP Renew Business 14.1 Laptop Bag (Bulk Qty.12)	3E5F9A6
	HP Renew Business 14.1 Sleeve (Bulk Qty. 24)	3E2U7A6
	HP Renew Executive 16 Laptop Backpack	6B8Y1AA
	HP Renew Executive 16 Laptop Bag	6B8Y2AA
	HP Renew Executive 14.1 Laptop Sleeve	6B8Y3AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6B8U4AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6H2D8AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6B8U6AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6H2D9AA
Docking station	HP USB-C Dock G5	26D32AA
	HP USB-C Dock G5	5TW10AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP Thunderbolt 120W G4 Dock	4JOA2AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
	HP USB-C G5 Essential Dock	72C71AA

Options and Accessories (sold separately and availability may vary by country)

Dongle	HP HDMI to VGA Adapter	H4F02AA
_	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to VGA Adapter	P7Z54AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to HDMI 2.0 Adapter	2PC54AA
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB-C to RJ45 Adapter G2	4Z534AA
	HP USB 3.0 to Gig RJ45 Adapter G2	4Z7Z7AA
	HP USB-C to DisplayPort Adapter G2	8Y8Y1AA
Hub	HP USB-C Travel Hub G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP Universal USB-C Multiport Hub	50H98AA
	HP 4K USB-C Multiport Hub	6G842AA
	HP 4K USB-C Multiport Hub	6G843AA
	HP Universal USB-C Hub and Laptop Charger Combo	ЭНОНЭАА
Keyboard/Combo	HP 320K Wired Keyboard	9SR37AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 965 BLK Ergonomic Wireless Keyboard	7E756AA
	HP 475 Dual-Mode Wireless Keyboard	7N7B9AA
	HP 405 Multi-Device Backlit Wired Keyboard	7N7C1AA
	HP 435 Programmable Bluetooth Wireless Keypad	7N7C3AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
Mouse	HP Wired 320M Mouse	9VA80AA
	HP Premium Wireless Mouse	1JR31AA
	HP Travel Bluetooth Mouse	6SP30AA
	HP Multi-Device 635 Black Wireless Mouse	1DOK2AA
	HP Creator 935 Black Wireless Mouse	1DOK8AA
	HP 235 Slim Wireless Mouse	4E407AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 715 Rechargeable Multi-Device Bluetooth Mouse	6E6F0AA
	HP 925 Ergonomic Vertical Wireless Mouse	6H1A5AA
Power	HP 65W USB-C LC Power Adapter	1РЗК6АА
	HP 65W USB-C LC Power Adapter	944V0AA



QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

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	HP 65W Gallium Nitride USB-C Laptop Charger	600Q7AA
	HP 65W Gallium Nitride USB-C Laptop Charger	600Q8AA
	HP 65W USB-C Laptop Charger	671R2AA
	HP 65W USB-C Laptop Charger	671R3AA
	HP 110W USB-C Laptop Charger	8B3Y2AA
Commodity	HP 2TB PCIe-4x4 NVMe TLC M.2 Solid State Drive	6D8L6AA
	HP USB External DVDRW Drive	F2B56AA
	HP USB External DVDRW Drive	Y3T76AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Keyed Cable Lock	1AJ39UT
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP Sure Key Cable Lock	6UW42AA
	HP Nano Combination Cable Lock	63B28AA
	HP Essential Nano Combination Cable Lock	63B31AA
Monitor	HP Z38c 37.5-inch Curved Display	Z4W65A4
	HP Z38c 37.5-inch Curved Display	Z4W65A7
	HP Z38c 37.5-inch Curved Display	Z4W65A8
	HP Z38c 37.5-inch Curved Display	Z4W65AT
	HP Z27k G3 4K USB-C Display	1B9T0A7
	HP Z27k G3 4K USB-C Display	1B9T0AA
	HP Z27k G3 4K USB-C Display	1B9T0AT
	HP Z27u G3 QHD USB-C Display	1B9X2A7
	HP Z27u G3 QHD USB-C Display	1B9X2AA
	HP Z27u G3 QHD USB-C Display	1B9X2AT
	HP Z24u G3 WUXGA USB-C Display	1C4Z6A7
	HP Z24u G3 WUXGA USB-C Display	1C4Z6AA
	HP Z24u G3 WUXGA USB-C Display	1C4Z6AT
	HP Z24u G3 WUXGA USB-C Display	1C4Z6E9
	HP Z24q G3 QHD Display	4Q8N4A7
	HP Z24q G3 QHD Display	4Q8N4AA
	HP Z24q G3 QHD Display	4Q8N4AT
	HP Z24q G3 QHD Display	4Q8N4E9
	HP Z24m G3 QHD Conferencing Display	4Q8N9A7
	HP Z24m G3 QHD Conferencing Display	4Q8N9AA
	HP Z24m G3 QHD Conferencing Display	4Q8N9AT
	HP Z24m G3 QHD Conferencing Display	4Q8N9E9
	HP Z32k G3 4K USB-C Display	50U19A7
	HP Z32k G3 4K USB-C Display	50U19AA
	HP Z32k G3 4K USB-C Display	50U19AT
	HP Z32k G3 4K USB-C Display	50U19E9



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Date of change:	Version History:	Description of change:
	From v1 to v2	

